

GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 4.8 - 6.0 GHz



Typical Applications

The HMC717LP3(E) is ideal for:

- Fixed Wireless and LTE/WiMAX/4G
- BTS & Infrastructure
- Repeaters and Femtocells
- Public Safety Radio
- Access Points

Features

Noise Figure: 1.1 dB

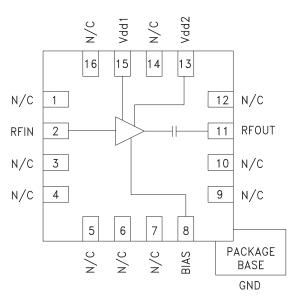
Gain: 16.5 dB

Output IP3: +31.5 dBm

Single Supply: +3V to +5V

16 Lead 3x3mm QFN Package: 9 mm²

Functional Diagram



General Description

The HMC717LP3(E) is a GaAs PHEMT MMIC Low Noise Amplifier that is ideal for fixed wireless and LTE/WiMAX/4G basestation front-end receivers operating between 4.8 and 6.0 GHz. The amplifier has been optimized to provide 1.1 dB noise figure, 16.5 dB gain and +31.5 dBm output IP3 from a single supply of +5V. Input and output return losses are excellent and the LNA requires minimal external matching and bias decoupling components. The HMC717LP3(E) can be biased with +3V to +5V and features an externally adjustable supply current which allows the designer to tailor the linearity performance of the LNA for each application.

Electrical Specifications

 $T_A = +25^{\circ}$ C, Rbias = 2k Ohms for Vdd = 5V, Rbias = 20k Ohms for Vdd = 3V^{[1][2]}

		Vdd = +3V		Vdd = +5V			
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		4.8 - 6.0			4.8 - 6.0		MHz
Gain	12	14.3		13.5	16.5		dB
Gain Variation Over Temperature		0.01			0.01		dB/ °C
Noise Figure		1.25	1.5		1.1	1.4	dB
Input Return Loss		13			13		dB
Output Return Loss		13			18		dB
Output Power for 1 dB Compression (P1dB)	12	14		15	18.5		dBm
Saturated Output Power (Psat)		15			19.5		dBm
Output Third Order Intercept (IP3)		25.5			31.5		dBm
Total Supply Current (Idd)		31	40		73	100	mA

^[1] Rbias resistor sets current, see application circuit herein

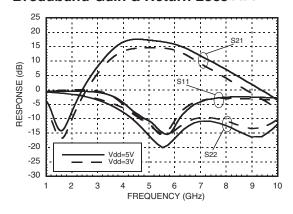
^[2] Vdd = Vdd1 = Vdd2



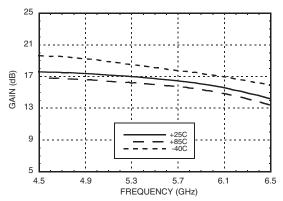
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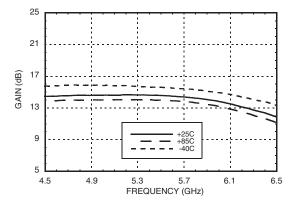
Broadband Gain & Return Loss [1][2]



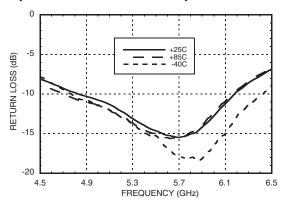
Gain vs. Temperature [1]



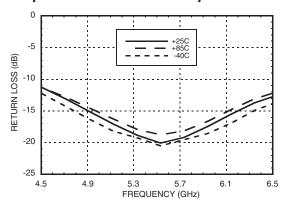
Gain vs. Temperature [2]



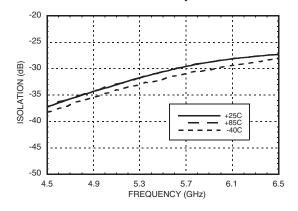
Input Return Loss vs. Temperature [1]



Output Return Loss vs. Temperature [1]



Reverse Isolation vs. Temperature [1]



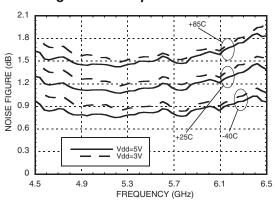
[1] Vdd = 5V, $Rbias = 2k\Omega$ [2] Vdd = 3V, $Rbias = 20k\Omega$



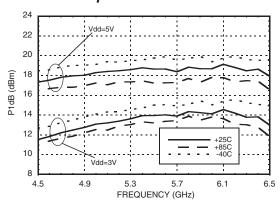
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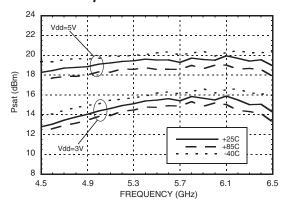
Noise Figure vs. Temperature [1] [2] [4]



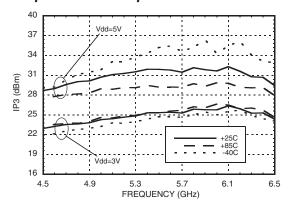
P1dB vs. Temperature [1] [2]



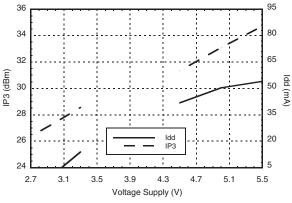
Psat vs. Temperature [1] [2]



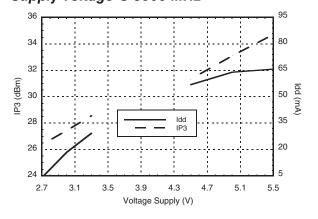
Output IP3 vs. Temperature [1] [2]



Output IP3 and Total Supply Current vs. Supply Voltage @ 4800 MHz [3]



Output IP3 and Total Supply Current vs. Supply Voltage @ 5900 MHz [3]



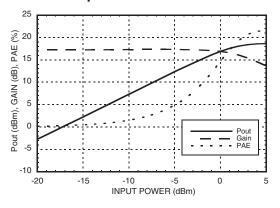
- [1] Vdd = 5V, Rbias = $2k \Omega$
- [2] Vdd = 3V, $Rbias = 20k\Omega$
- [3] Rbias = $2k\Omega$ for Vdd = 5V, Rbias = $20k\Omega$ for Vdd = 3V
- [4] Measurement reference plane shown on evaluation PCB drawing.



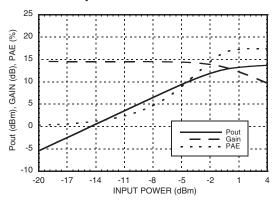
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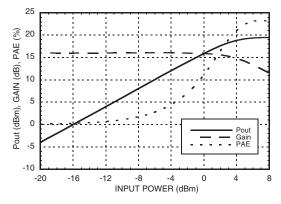
Power Compression @ 4800 MHz [1]



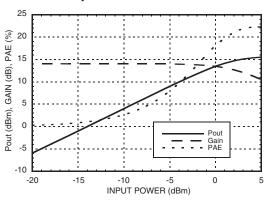
Power Compression @ 4800 MHz [2]



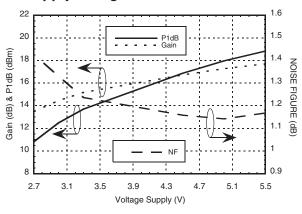
Power Compression @ 5900 MHz [1]



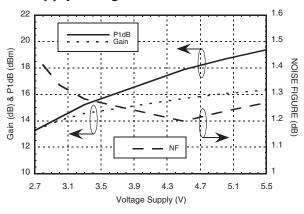
Power Compression @ 5900 MHz [2]



Gain, Power & Noise Figure vs. Supply Voltage @ 4800 MHz [3]



Gain, Power & Noise Figure vs. Supply Voltage @ 5900 MHz [3]



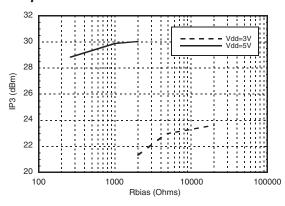
[1] Vdd = 5V, $Rbias = 2k \Omega$ [2] Vdd = 3V, $Rbias = 20k\Omega$ [3] $Rbias = 2k\Omega$ for Vdd = 5V, $Rbias = 20k\Omega$ for Vdd = 3V



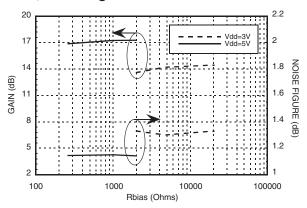
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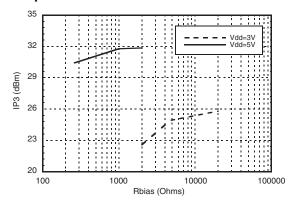
Output IP3 vs. Rbias @ 4800 MHz



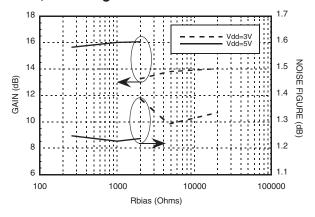
Gain, Noise Figure & Rbias @ 4800 MHz



Output IP3 vs. Rbias @ 5900 MHz



Gain, Noise Figure & Rbias @ 5900 MHz







GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 4.8 - 6.0 GHz

Absolute Bias Resistor Range & Recommended Bias Resistor Values

\/dd /\/\		ldd (mA)			
Vdd (V)	Min	Max	Recommended	idd (IIIA)	
			2k	20	
3V	2k ^[1]	Open Circuit	4.7k	26	
			20k	31	
5V 150 ^[2]		261	50		
	150 ^[2]	Open Circuit	1k	65	
			2k	73	

^[1] With Vdd= 3V and Rbias $< 2k\Omega$ may result in the part becoming conditionally stable which is not recommended.

Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+5.5V
RF Input Power (RFIN) (Vdd = +5 Vdc)	+10 dBm
Channel Temperature	150 °C
Continuous Pdiss (T= 85 °C) (derate 7.73 mW/°C above 85 °C)	0.5 W
Thermal Resistance (channel to ground paddle)	129.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



Typical Supply Current vs. Supply Voltage

(Rbias = $2k\Omega$ for Vdd = 5V, Rbias = $20k\Omega$ for Vdd = 3V)

Vdd (V)	Idd (mA)
2.7	23
3.0	31
3.3	39
4.5	60
5.0	73
5.5	85

Note: Amplifier will operate over full voltage ranges shown above.

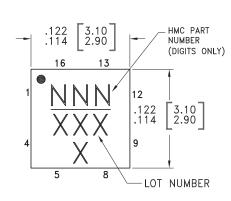
^[2] With Vdd = 5V and Rbias<150 Ω may result in the part becoming conditionally stable which is not recommended.

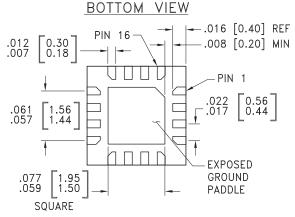


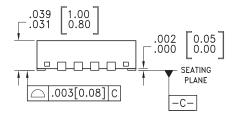
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Outline Drawing







NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- $\label{eq:all_stable_equation} \text{4. PAD BURR LENGTH SHALL BE } 0.15 \text{mm MAXIMUM}. \\ \text{PAD BURR HEIGHT SHALL BE } 0.05 \text{mm MAXIMUM}. \\$
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC717LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	717 XXXX
HMC717LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	717 XXXX

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX



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ROHS V

Pin Descriptions

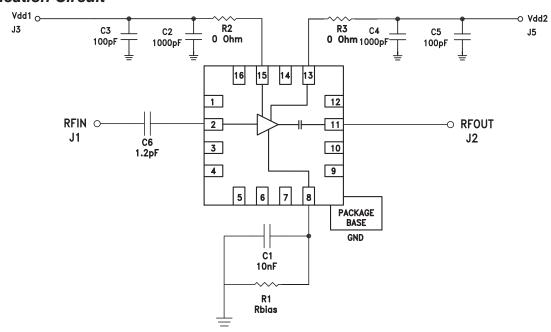
Pin Number	Function	Description	Interface Schematic
1, 3 - 7, 9, 10, 12, 14, 16	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
2	RFIN	This pin is DC coupled See the application circuit for off-chip component.	RFIN O ESD
8	BIAS	This pin is used to set the DC current of the amplifier by selection of the external bias resistor. See application circuit.	BIAS ESD =
11	RFOUT	This pin is AC coupled and matched to 50 Ohms	RFOUT ESD =
13, 15	Vdd2, Vdd1	Power supply voltage. Bypass capacitors are required. See application circuit.	Vdd1,2 ESD
	GND	Package bottom must be connected to RF/DC ground	GND



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Application Circuit

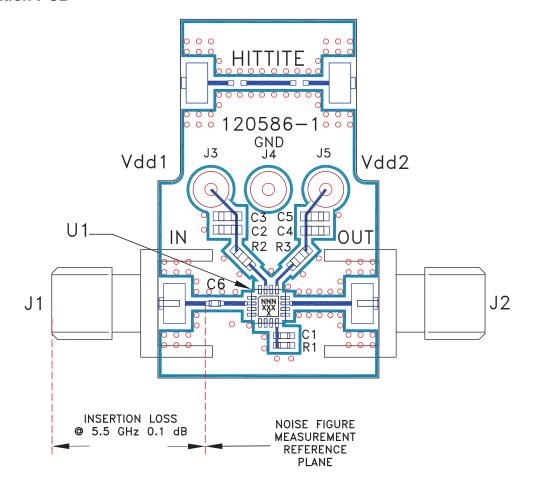






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Evaluation PCB



List of Materials for Evaluation PCB 122416 [1]

Item	Description	
J1, J2	PCB Mount SMA Connector	
J3 - J5	DC Pins	
C1	10 nF Capacitor, 0402 Pkg.	
C2, C4	1000 pF Capacitor, 0603 Pkg.	
C3, C5	100 pF Capacitor, 0603 Pkg.	
C6	1.2 pF Capacitor, 0402 Pkg.	
R1	2k Ohm Resistor, 0402 Pkg. (Rbias)	
R2, R3	0 Ohm Resistor, 0402 Pkg.	
U1	HMC717LP3(E) Amplifier	
PCB [2]	120586 Evaluation PCB	

 $[\]ensuremath{[1]}$ Reference this number when ordering complete evaluation PCB

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350.